Advanced Alloy Interconnect Development

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Interconnect Development

Objectives:

- Develop cost-effective, optimized materials for intermediate temperature interconnect and its interface applications.
- Identify and understand degradation processes in candidate alloys.

Approach:

- Screen testing of conventional and newly developed alloys (chemical, electrical, mechanical properties, cost).
- Investigation of oxidation/corrosion behavior of alloys and scale stability under SOFC operating conditions.
- Materials development.
 - Surface modification (surface doping, overlay coatings, cladding).
 - Bulk modification or alloy development.
 - Cathode/interconnect interfaces.

Highlights of Achievements

- Developed standardized testing capability for evaluation of SOFC interconnect alloys
- Identified and evaluated suitable candidate alloys using systematic screening techniques.
- Developed conductive oxide coated alloy interconnects for improved stability.
- Evaluated newly developed alloys, including Crofer22 APU and ZMG232.
- Examined oxidation/corrosion behavior of steels and superalloys.

Evaluation of Newly Developed Alloys

FSS	Fe	Cr	С	Mn	Si	Ti	AI	Р	S	RE
Crofer22 APU	Bal.	22.0	0.005	0.5		0.08		0.016	0.002	0.06La
ZMG232	Bal.	22.0	0.02	0.5	0.40		0.21			0.04La 0.02Zr

Crofer is a trade mark of ThyssenKrupp; ZMG is a trade mark of Hitachi Metals, Ltd.

Properties relevant to SOFC applications:

- Thermal expansion;
- Scale growth and oxidation resistance;
- Scale electrical conductivity;
- Scale evaporation;
- Compatibility with seals;
- Scale adherence and seal bonding strengths.

Crofer22 APU: <u>Thermal Expansion</u>

Some Fe-Cr ferritic compositions (including Crofer22 APU) demonstrate good CTE matching to the Ni/YSZ anode.







Crofer22 APU was heat treated at 800°C for 1,200 hours in air



Extrapolation of the 2,000 h test gives an ASR of about 200 m Ω .cm² after 40,000 h.







Chromia Scale Evaporation

The chromia evaporation rate is relatively low, compared with other alloys.



Evaluation of ZMG232





Newly developed ferritic stainless steels demonstrate:

- Good CTE matching;
- Reduced scale electrical resistance;
- Increased scale adherence;
- Decreased chromia evaporation.

There is HOWEVER, a need for further improvement in:

- Scale electrical conductivity in the long term;
- Scale evaporation;
- Scale adherence and sealing effectiveness;
- Corrosion resistance under dual environments.

For >700°C applications

Dual Atmosphere Study

		FSS	Fe	Ni	Cr	С	Mn	Si	Мо	W	Ti	AI	RE
FeSS	<u> </u>	AISI430	Bal.		16.0	0.1	1.0	1.0				-	
		Crofer22 APU	Bal.		22.0	0.005	0.5				0.08		0.06La
		E-brite	Bal.		26.0	0.001	0.01	0.025					
NiBS	{	Haynes 230	1.5	Bal.	22.0	0.10	0.5	0.4	1.4	14		0.3	0.02La .005B





Variables:

Temperature, 700~800°C

Time, 300 hours

Fuel, H_2 +3% H_2O

Heating, isothermal and cycling.

Crofer22 APU: Structure of Scales

Grown on the coupon in air only and on the air side of the coupon that was **ISOTHERMALLY** heat-treated at 800°C, 300 hours.



Air exposure at both sides



Air-side of dual exposures



Crofer22 APU: <u>Structure of Scales</u>

Grown on the coupon in fuel $(H_2+3\%H_2O)$ only and on the fuel side of the coupon that was **ISOTHERMALLY** heat-treated at 800°C, 300 hours.



Fuel exposure at both sides





Crofer22 APU: <u>Structure of Scales</u>

Grown on the coupon in air only and on the air Air-side of dual test

side of the coupon that was heat-treated at 800°C for 300 hours, with three thermal cycles.





AISI430: Scale Microstructures

Air exposure at both sides

Air-side of dual exposures



E-brite: Scale Microstructures



$(H_2+3\%H_2O)$ at both sides

Fuel side of dual exposures



Haynes230: Structure of Scales

Grown on the coupon in <u>air only</u> and on the <u>air side</u> of the coupon that was <u>isothermally</u> heat-treated at 800°C, 300 hours.

1200 Air of Dual Air/Air • Cr_2O_3 1000 △ (Mn,Ni,Cr)₃O₄ ♦ NiO Relative Intensity (A. U.) NiO 800 600 400 - WWW MW 200 0 30 35 40 45 **2**0

Air exposure at both sides



Air side of dual exposures



Haynes230: Cross-Sections

Grown on the coupon in <u>air only</u> and on the <u>air side</u> of the coupon that was <u>isothermally</u> heat-treated at 800°C, 300 hours.



Haynes230: Structure of Scales

Grown on the coupon in <u>fuel only</u> and on the <u>fuel side</u> of the coupon that was <u>isothermally</u> heat-treated at 800°C, 300 hours.



(H₂+3%H₂O) at both sides



Fuel side of dual atmospheres



Haynes230: Cross-Sections

Grown on the coupon in <u>fuel only</u> and on the <u>fuel side</u> of the coupon that was <u>isothermally</u> heat-treated at 800°C, 300 hours.



20 k U

X5,000

5 Mm

03s647a



<u>Summaries</u>

The Dual Atmosphere exposure can lead to an anomalous oxidation/ corrosion behavior of oxidation resistant alloys:

For ferritic stainless steels with relative low chromium level, dual exposure enhances the iron transport in scale on the airside, leading to hematite formation and a locallized attack.

For **Ni-based superalloys**, e.g. Haynes230 with 22% Cr, dual exposure facilitates the formation of a uniform chromia dominated scale.



<u>Comparison</u>

	Haynes230 Ni-base superalloy Ni-22Cr-14W-2Mo5Mn	Crofer22 APU Stainless steel Fe-22Cr5Mn			
vpansion	15.2 RT-800°C	12.2 RT-800°C			
Thermal ext V106.K-1 resistant	0.36 , 800°C 0.05 , 700°C	7.0 , 800°C 2.0 , 700°C			
Oxidation 10	10.0 , 800°C 5.0 , 700°C	9.0 , 800°C 4.0 , 700°C			
ASR, mp. ch. of oxida ASR, 600h of oxida	Enhanced formation of uniform chromia scale	Grow hematite to accelerate attack			
Dual atmosfests	865 , RT 605 , 760°C	443 , RT <100 , 760°C			
Ultimate ter. (MPa)	Very easy	Fairly easy			
Manufacturau	Fairly expensive	Inexpensive			
Daw cost					

Future Work

Identifying Issues and Understanding

Continue the systematic screening studies, with emphasis on dual atmosphere studies, including extension of dual atmosphere studies to air vs. reformate invironments.

Study scale evaporation.

Materials Development

Modifications (bulk and/or surface) to Fe and Ni based alloys

 Cathode/interconnect interfaces.

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